

Integrated Development Environment e² studio

Creating and executing build CMake project

Introduction

CMake's responsibility is to generate native build tool files from the platform and compiler independent configuration files named CMakeLists.txt.

This document explains processes how to create CMake project in e² studio and execute Build.

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1. Overview

CMake's responsibility is to generate native build tool files from the platform and compiler independent configuration files named CMakeLists.txt.

 e^2 studio supports CMake project since version 2020-04. e^2 studio need some configurations to work with CMake commands and build with its generated makefile. This document explains processes how to create CMake project in e^2 studio and execute Build.

• This document does not explain processes how to create CMake toolchain file and configuration file. Please prepare those files by yourself.

2. Installation

At first, please download and install the following tools from the website.

- e² studio <u>e² studio | Renesas</u> (2021-04 used in this example)
- CMake <u>Download | CMake</u> (version 3.20.3 used in this example)
- GNU Make for windows (If you already installed e² studio, you can use "make" in e² studio.) <u>Make for Windows (sourceforge.net)</u> (version 3.81 used in this example)



3. Creating a CMake project

Start e² studio and create CMake project in accordance with the following steps.

- 1) Select menu items [File] > [New] > [C/ C++ Project].
- On the [New C/C++ Project Templates for New C/C++ Project] dialog, select [CMake] > [Empty or Exiting CMake Project]. Then press [Next >] button.

	ew C/C++ Project			
All CMake Make Renesas Debug	CMake Project A CMake project with a Hello Wo	orld executa	ble to get si	arteo
Renesas RA Renesas RE Renesas RL78 Renesas RX	Empty or Existing CMake Pro Create a CMake project with no fi create one over existing content.	iles. Can be	used to	

Figure 1

- 3) After moving to [New CMake Project Specify properties of new CMake project] screen, put an arbitrary name in [Project name] field (e.g. "Sample"). Then, click [Finish].
- 4) An empty project will be created.
- 5) Copy source files, toolchain file and configuration file for CMake. And paste them into the created project.

* When you select [CMake Project] on the [New C/C++ Project - Templates for New C/C++ Project] dialog, a created project has created project name>.cpp and CMakeLists.txt.



4. Modifying items for Builder configuration

There is no command to execute Build in the created project. To execute Build, you need to add "CMake" and "Make" setting items for the builder configuration of the created project. Add the items in accordance with the following steps.

4.1 Disable CDT Core Builder

CDT Core Builder in builder configuration is not used to execute Build. So, CDT Core Builder in builder configuration need to be disable. This chapter explains how to disable CDT Core Builder commands as builder configuration.

- 1) Select "Sample [Configuration]" in the [Project Explorer]. Then, open right-click context menu and select [Properties].
- 2) In [Properties] dialog, select [Builders] in the tree box on the left.
- In a normal e² studio project, the makefile is created by the CDT builder, but here uncheck registered [CDT Core Builder] and let CMake create it.
- 4) A warning dialog turns up. Then, click [OK].

Configure the builders for the	e project:	New
Builder		1
lvanced operation. Disabling a j	project builder can hav	ve many side-effects.
		ОК



5) Proceed to the next chapter.

4.2 Adding CMake configuration

This chapter explains how to add CMake commands as builder configuration. CMake will generate "Makefile" with the following settings in the toolchain and configuration files.

- 6) Click [New...], then [choose configuration type] dialog will pop up. Select [Program] and click [OK] in the dialog.
- 7) [Edit Configuration] will be displayed. Input an arbitrary name in [Name:] field. (e.g. "CMake").
- 8) Click [OK] after setting the following parameters.
 - [Main] tab
 - [Location:] Specify a location of installed cmake.exe. (e.g. <CMake install folder>\bin\cmake.exe)
 - [Working Directory:] Specify the "\${workspace_loc:/\${project_name}}".
 - [Arguments:] Specify CMake command parameters. (e.g. -H. -B_builds -G "Unix Makefiles" -DCMAKE_TOOLCHAIN_FILE=./ccrx.cmake)
 - [Refresh] tab



Check [Refresh resources upon completion.].
 Select [The entire workspace].

e Edit Configuration	e Edit Configuration — — X
Edit launch configuration properties	Edit launch configuration properties Create a configuration that will run a program during builds
Name: CMake Image: Main Refresh Refres	Name: CMake Image: Main Refresh Environment Build Options Image: Refresh resources upon completion. Image: The entire workspace The selected resource Image: The project containing the selected resource The folder containing the selected resource Image: Specific resources Specify Resources
Arguments: -HB_builds -G "Unix Makefiles" -DCMAKE_TOOLCHAIN_FILE=ccrx.cmake Variables Note: Enclose an argument containing spaces using double-quotes ("). Show Command Line Revert Apply	Show Command Line Revert Apply
OK Cancel	OK Cancel

Figure 3

- [Environment] tab
 - [Environment variables to set:] Add the environment variables needed to run CMake by click [Add...] button.
 - Check [Append environment to native environment]

	toolchain in a project is C/C++ all folder>\bin" in Path as enviro		(Family			
💽 Edit Co	e Edit Configuration					
	:h configuration properties onfiguration that will run a program during builds					
Name: C	Make					
E Main	🔗 Refresh 🖾 Environment 🔁 Build Options					
	Environment variables to set:					
Variable		Add				
Path	C:¥Program Files (x86)¥Renesas¥RX¥3_3_0¥bin	Select				
		Edit				
		Remove				
		Сору				
		Paste				
	nd environment to native environment cce native environment with specified environment					
	Show Command Line Revert	Apply				
?	OK Cancel					
	Figure 4					



9) Proceed to the next chapter.

4.3 Adding Make configuration

This chapter explains how to add Make commands as builder configuration. Build is executed with the generated makefile. It is the continuity of setting on [Builder] panel.

- 10) Click [New...].
- 11) [Choose configuration type] dialog will pop up. Select [Program] and click [OK] in the dialog.
- 12) [Edit Configuration] will be displayed. Input an arbitrary name in [Name:] field. (e.g. "Make").
- 13) Click [OK] after setting the following parameters.
 - [Main] tab
 - [Location:]

Specify location of installed make.exe. (e.g. : <make install folder>\bin\make.exe)

When using make.exe of e² studio, check make.exe folder by following steps below.

- a. Select [Help] > [About e^2 studio] on the menu bar.
- b. In [About e² studio] dialog, click [Installation Details].
- c. Click [Support Folders] tab in [e² studio Installation details] dialog.
- Click [e² studio support area:] to confirm the location.
 (e.g. C:\Users\<User name>\.eclipse\com.renesas.platform_XXXX\Utilities\make.exe) The part "XXXX" differs from each version of e² studio.

About e ² stud				\times
	Renesas e² studio			
~2	Version: 2021-04 (21.4.0) Build Id: R20210330-1207			
e² studio	Installation Details			
	ftware Installation History Features Plug-ins Configuration Renesas Device		upport Fo	olders
	support area: <u>file:/C:/Users/a5088664/.eclipse/com.renesas.platform_1736760032</u> download area: <u>file:/C:/Users/a5088664/.eclipse/com.renesas.platform_downloa</u>	201 C		
		201 C		
		201 C	Close	:
e² studio o			Close	2

- [Working Directory:] Specify "\${workspace_loc:/\${project_name}/<makefile folder>}" (e.g. \${workspace_loc:/\${project_name}/_builds)
- [Arguments:] Specify "all".
- [Refresh] tab
 - Check [Refresh resources upon completion.]. Select [The entire workspace].



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e Edit Configuration	e Edit Configuration
Edit launch configuration properties Image: Create a configuration that will run a program during builds	Edit launch configuration properties Create a configuration that will run a program during builds
Name: Make Main @ Refresh T Environment Build Options Location: E:#Program Files (x86)¥make¥bin¥make.exe Browse Workspace Browse File System	Name: Make Main Refresh Refresh Refresh The entire workspace O The selected resource The selected resource
Working Directory: \${workspace_loc:/\${project_name}/_builds} Browse Workspace Browse File System Variables Arguments: all	 ○ The project containing the selected resource ○ The folder containing the selected resource ○ Specific resources Specify Resources ☑ Recursively include sub-folders
Variables Note: Enclose an argument containing spaces using double-quotes ("). Show Command Line Revert Apply	Show Command Line Revert Apply
OK Cancel	OK Cancel

Figure 6

- [Environment] tab
 - [Environment variables to set:] Add the environment variables needed to run Make by click [Add...] button.
 - Check [Append environment to native environment]

For example, in case of using toolchain in a project is C/C++ Compiler Package for RX Family CC-RX, specify the following environment variables using [Add...] button.

- Variable name: Path Value: <make install folder>\bin;<CC-RX install folder>\bin
- Variable name: BIN_RX Value: <CC-RX install folder>\bin
- Variable name: INC_RX Value: <CC-RX install folder>\include



🕑 Edit Confi	guration —			
	configuration properties			
Create a configuration that will run a program during builds				
Name: Make	Name: Make			
📄 Main 🥪	Refresh 🚾 Environment 🔁 Build Options			
Environment	t variables to set:			
Variable	Value	Add		
BIN_RX	C:¥Program Files (x86)¥Renesas¥RX¥3_3_0¥bin	Select		
INC_RX Path	C:¥Program Files (x86)¥Renesas¥RX¥3_3_0¥include E:¥Program Files (x86)¥make¥bin;C:¥Program Files (x86)¥Renesas¥RX¥3_3_0¥bin	Edit		
		Remove		
		Сору		
		Paste		
	environment to native environment			
OReplace	native environment with specified environment			
	Show Command Line Revert			
	Show Command Line Revert	Apply		
?	01			
0	OK	Cancel		
	F igure 7			
	Figure 7			

14) Click [Apply and Close] on [Properties] dialog.

rce Configure the builders for the project: General General Configure the builders for the project: General General	<u>N</u> ew Import <u>E</u> dit <u>R</u> emove <u>Up</u> Down
t References as QE ebug Settings ags	

Figure 8



5. Executing Build

After editing source files, execute build. By following steps below, [CMake] and [Make] set as builder's configuration will run, and [.abs file] will be generated in [_builds] folder.

- 1) Select [Sample [Configuration]] in [Project Explorer]. Then, execute on any of the following procedures.
 - Click [Build Project] on the right click context menu.
 - Click [Project] > [Build Project] on the menu bar.

Once build is executed, execution results are output on [Console] view.

•	- 0	
📮 Console 🖂	🔳 🗶 💥 📴 🖓 🗗 💭 🚽 🗳 🖵 🕶 😁	- 0
<terminated> Make</terminated>	[Program] E:¥Program Files (x86)¥make¥bin¥make.exe (Jun 22, 2021, 5:25:16 PM – 5:25:4	1 PM)
[5%] Generate [16%] Generate [15%] Generate [21%] Generate [21%] Generate [36%] Generate [36%] Generate [42%] Generate Scanning depend [52%] Building [57%] Building [63%] Building [63%] Building [73%] Building [73%] Building [84%] Building [84%] Building [94%] Building [94%] Building [100%] Linking of Library Generate	<pre>dependency: CMakeFiles/CCRX_Project.dir/generate/lowlvl.src.d dependency: CMakeFiles/CCRX_Project.dir/src/main.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/vecttbl.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/sbrk.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/lowsrc.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/intprg.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/intprg.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/intprg.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/intprg.c.d dependency: CMakeFiles/CCRX_Project.dir/generate/dbsct.c.d encies of target CCRX_Project.dir/generate/dbsct.c.obj C object CMakeFiles/CCRX_Project.dir/generate/dbsct.c.obj C object CMakeFiles/CCRX_Project.dir/generate/lowsrc.c.obj C executable CCRX_Project.dir/generate/lowsrc.obj</pre>	
Renesas Optimiz: Converter:	ing Linker Completed	
X Converter: Loading input f Parsing the ELF 27 segments req Converting the I Constructing the Saving the ELF Build Finished.		
1		
× .		

Figure 9



Revision History

		Description		
Rev.	Date	Page	Summary	
1.00	Dec.25.20	-	New creation	
2.00	Jun.30.21	all	Update whole.	
			- Remove unnecessary information.	
			- Separate toolchain-specific settings.	
2.01	Jun.28.22	P.6	Replace "The part "XXXX" differs from each user." to "The part	
			"XXXX" differs from each version of e ² studio."	



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a systemevaluation test for the given product.

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

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